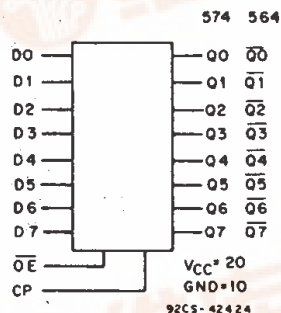




Data sheet acquired from Harris Semiconductor  
SCHS292

# CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574



FUNCTIONAL DIAGRAM

## Octal D-Type Flip-Flop, 3-State Positive-Edge-Triggered

CD54/74AC/ACT564 - Inverting  
CD54/74AC/ACT574 - Non-Inverting

### Type Features:

- Buffered inputs
- Typical propagation delay:  
6.5 ns @  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $C_L = 50\text{ pF}$

The RCA-CD54/74AC564 and CD54/74AC574 and the CD54/74ACT564 and CD54/74ACT574 octal D-type, 3-state, positive-edge-triggered flip-flops use the RCA ADVANCED CMOS technology. The eight flip-flops enter data into their registers on the LOW-to-HIGH transition of the clock (CP). The Output Enable ( $\overline{OE}$ ) controls the 3-state outputs and is independent of the register operation. When the Output Enable ( $\overline{OE}$ ) is HIGH, the outputs are in the high-impedance state. The CD54/74AC/ACT564 and CD54/74AC/ACT574 share the same pin configurations; the CD54/74AC/ACT564, however, has inverted outputs and the CD54/74AC/ACT574 has non-inverted outputs.

The CD74AC/ACT564 and CD74AC/ACT574 are supplied in 20-lead dual-in-line plastic packages (E suffix) and in 20-lead dual-in-line small-outline plastic packages (M suffix). Both package types are operable over the following temperature ranges: Commercial (0 to  $70^\circ\text{C}$ ); Industrial ( $-40$  to  $+85^\circ\text{C}$ ); and Extended Industrial/Military ( $-55$  to  $+125^\circ\text{C}$ ).

The CD54AC/ACT564 and CD54AC/ACT574, available in chip form (H suffix), are operable over the  $-55$  to  $+125^\circ\text{C}$  temperature range.

### Family Features:

- Exceeds 2-kV ESD Protection - MIL-STD-883, Method 3015
- SCR-Latchup-resistant CMOS process and circuit design
- Speed of bipolar FAST\*/AS/S with significantly reduced power consumption
- Balanced propagation delays
- AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply
- $\pm 24\text{-mA}$  output drive current
  - Fanout to 15 FAST\* ICs
  - Drives 50-ohm transmission lines

\*FAST is a Registered Trademark of Fairchild Semiconductor Corp.

TRUTH TABLE

INPUTS			OUTPUTS	
			564	574
$\overline{OE}$	CP	$D_n$	$\overline{Q_n}$	$Q_n$
L		H	L	H
L		L	H	L
L	L	X	$\overline{QO}$	QO
H	X	X	Z	Z

H = High level (steady state)

L = Low level (steady state)

X = Don't care

= Transition from low to high level

QO = The level of Q before the indicated steady-state input conditions were established

$\overline{QO}$  = The level of  $\overline{Q}$  before the indicated steady-state input conditions were established.

Z = High impedance

## Technical Data

# CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574

### MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE ( $V_{CC}$ )	-0.5 to 6 V
DC INPUT DIODE CURRENT, $I_{IK}$ (for $V_i < -0.5$ V or $V_i > V_{CC} + 0.5$ V)	$\pm 20$ mA
DC OUTPUT DIODE CURRENT, $I_{OK}$ (for $V_o < -0.5$ V or $V_o > V_{CC} + 0.5$ V)	$\pm 50$ mA
DC OUTPUT SOURCE OR SINK CURRENT per Output Pin, $I_o$ (for $V_o > -0.5$ V or $V_o < V_{CC} + 0.5$ V)	$\pm 50$ mA
DC $V_{CC}$ or GROUND CURRENT ( $I_{CC}$ or $I_{GND}$ )	$\pm 100$ mA*
POWER DISSIPATION PER PACKAGE ( $P_D$ ):	
For $T_A = -55$ to $+100^\circ\text{C}$ (PACKAGE TYPE E)	500 mW
For $T_A = +100$ to $+125^\circ\text{C}$ (PACKAGE TYPE E)	Derate Linearly at 8 mW/ $^\circ\text{C}$ to 300 mW
For $T_A = -55$ to $+70^\circ\text{C}$ (PACKAGE TYPE M)	400 mW
For $T_A = +70$ to $+125^\circ\text{C}$ (PACKAGE TYPE M)	Derate Linearly at 6 mW/ $^\circ\text{C}$ to 70 mW
OPERATING-TEMPERATURE RANGE ( $T_A$ ):	$-55$ to $+125^\circ\text{C}$
STORAGE TEMPERATURE ( $T_{stg}$ )	$-65$ to $+150^\circ\text{C}$
LEAD TEMPERATURE (DURING SOLDERING):	
At distance $1/16 \pm 1/32$ in. ( $1.59 \pm 0.79$ mm) from case for 10 s maximum	$+265^\circ\text{C}$
Unit inserted into PC board min. thickness $1/16$ in. ( $1.59$ mm) with solder contacting lead tips only	$+300^\circ\text{C}$

\*For up to 4 outputs per device; add  $\pm 25$  mA for each additional output.

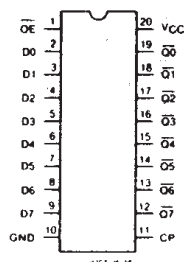
### RECOMMENDED OPERATING CONDITIONS:

For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

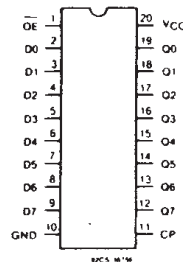
CHARACTERISTIC	LIMITS		UNITS
	MIN.	MAX.	
Supply-Voltage Range, $V_{CC}$ *, (For $T_A$ = Full Package-Temperature Range)			
AC Types	1.5	5.5	V
ACT Types	4.5	5.5	V
DC Input or Output Voltage, $V_i$ , $V_o$	0	$V_{CC}$	V
Operating Temperature, $T_A$ :	$-55$	$+125$	$^\circ\text{C}$
Input Rise and Fall Slew Rate, $dt/dv$			
at 1.5 V to 3 V (AC Types)	0	50	ns/V
at 3.6 V to 5.5 V (AC Types)	0	20	ns/V
at 4.5 V to 5.5 V (ACT Types)	0	10	ns/V

\*Unless otherwise specified, all voltages are referenced to ground.

### TERMINAL ASSIGNMENT DIAGRAMS



CD54/74AC/ACT564



CD54/74AC/ACT574

Technical Data

# CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574

STATIC ELECTRICAL CHARACTERISTICS: AC Series

CHARACTERISTICS	TEST CONDITIONS		V <sub>CC</sub> (V)	AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C						UNITS
				+25		-40 to +85		-55 to +125		
	V <sub>I</sub> (V)	I <sub>O</sub> (mA)		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
High-Level Input Voltage V <sub>IH</sub>			1.5	1.2	—	1.2	—	1.2	—	V
			3	2.1	—	2.1	—	2.1	—	
			5.5	3.85	—	3.85	—	3.85	—	
Low-Level Input Voltage V <sub>IL</sub>			1.5	—	0.3	—	0.3	—	0.3	V
			3	—	0.9	—	0.9	—	0.9	
			5.5	—	1.65	—	1.65	—	1.65	
High-Level Output Voltage V <sub>OH</sub>	V <sub>IH</sub> or V <sub>IL</sub>	-0.05	1.5	1.4	—	1.4	—	1.4	—	V
		-0.05	3	2.9	—	2.9	—	2.9	—	
		-0.05	4.5	4.4	—	4.4	—	4.4	—	
		-4	3	2.58	—	2.48	—	2.4	—	
		-24	4.5	3.94	—	3.8	—	3.7	—	
	#, * {	-75	5.5	—	—	3.85	—	—	—	
		-50	5.5	—	—	—	—	3.85	—	
Low-Level Output Voltage V <sub>OL</sub>	V <sub>IH</sub> or V <sub>IL</sub>	0.05	1.5	—	0.1	—	0.1	—	0.1	V
		0.05	3	—	0.1	—	0.1	—	0.1	
		0.05	4.5	—	0.1	—	0.1	—	0.1	
		12	3	—	0.36	—	0.44	—	0.5	
		24	4.5	—	0.36	—	0.44	—	0.5	
	#, * {	75	5.5	—	—	—	1.65	—	—	
		50	5.5	—	—	—	—	—	1.65	
Input Leakage Current I <sub>I</sub>	V <sub>CC</sub> or GND		5.5	—	±0.1	—	±1	—	±1	μA
3-State Leakage Current I <sub>OZ</sub>	V <sub>IH</sub> or V <sub>IL</sub>  V <sub>O</sub> = V <sub>CC</sub> or GND		5.5	—	±0.5	—	±5	—	±10	μA
Quiescent Supply Current, MSI I <sub>CC</sub>	V <sub>CC</sub> or GND	0	5.5	—	8	—	80	—	160	μA

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

\*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C. 75 ohms at +125°C.

# Technical Data

## CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574

### STATIC ELECTRICAL CHARACTERISTICS: ACT Series

CHARACTERISTICS	TEST CONDITIONS		$V_{CC}$ (V)	AMBIENT TEMPERATURE ( $T_A$ ) - °C						UNITS
	$V_I$ (V)	$I_O$ (mA)		+25		-40 to +85		-55 to +125		
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
High-Level Input Voltage $V_{IH}$			4.5 to 5.5	2	—	2	—	2	—	V
Low-Level Input Voltage $V_{IL}$			4.5 to 5.5	—	0.8	—	0.8	—	0.8	V
High-Level Output Voltage $V_{OH}$	$V_{IH}$ or $V_{IL}$ #, *	-0.05	4.5	4.4	—	4.4	—	4.4	—	V
		-24	4.5	3.94	—	3.8	—	3.7	—	
		-75	5.5	—	—	3.85	—	—	—	
		-50	5.5	—	—	—	—	3.85	—	
Low-Level Output Voltage $V_{OL}$	$V_{IH}$ or $V_{IL}$ #, *	0.05	4.5	—	±0.1	—	±1	—	±1	V
		24	4.5	—	0.36	—	0.44	—	0.5	
		75	5.5	—	—	—	1.65	—	—	
		50	5.5	—	—	—	—	—	1.65	
Input Leakage Current $I_i$	$V_{CC}$ or GND		5.5	—	±0.1	—	±1	—	±1	μA
3-State Leakage Current $I_{OZ}$	$V_{IH}$ or $V_{IL}$ $V_O = V_{CC}$ or GND		5.5	—	±0.5	—	±5	—	±10	μA
Quiescent Supply Current, MSI $I_{CC}$	$V_{CC}$ or GND	0	5.5	—	8	—	80	—	160	μA
Additional Quiescent Supply Current per Input Pin TTL Inputs High 1 Unit Load $\Delta I_{CC}$	$V_{CC}-2.1$		4.5 to 5.5	—	2.4	—	2.8	—	3	mA

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

\*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

ACT INPUT LOADING TABLE

INPUT	UNIT LOADS*
D, $\overline{OE}$	0.7
CP	1.17

\*Unit load is  $\Delta I_{CC}$  limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

# CD54/74AC564, CD54/74AC574

## CD54/74ACT564, CD54/74ACT574

## PREREQUISITE FOR SWITCHING: AC Series

CHARACTERISTICS	SYMBOL	V <sub>CC</sub> (V)	AMBIENT TEMPERATURE (T <sub>A</sub> ) -°C				UNITS
			-40 to +85		-55 to +125		
			MIN.	MAX.	MIN.	MAX.	
Clock Pulse Width	t <sub>w</sub>	1.5 3.3* 5†	44 4.9 3.5	— — —	50 5.6 4	— — —	ns
Setup Time Data to Clock	t <sub>su</sub>	1.5 3.3 5	2 2 2	— — —	2 2 2	— — —	ns
Hold Time Data to Clock	t <sub>h</sub>	1.5 3.3 5	2 2 2	— — —	2 2 2	— — —	ns
Maximum Clock Frequency	f <sub>MAX</sub>	1.5 3.3 5	11 101 143	— — —	10 89 125	— — —	MHz

\*3.3 V: min. is @ 3 V

†5 V: min. is @ 4.5 V

SWITCHING CHARACTERISTICS: AC Series; t<sub>r</sub>, t<sub>f</sub> = 3 ns, C<sub>L</sub> = 50 pF

CHARACTERISTICS	SYMBOL	V <sub>CC</sub> (V)	AMBIENT TEMPERATURE (T <sub>A</sub> ) -°C				UNITS
			-40 to +85		-55 to +125		
			MIN.	MAX.	MIN.	MAX.	
Propagation Delays: Clock to Q AC574	t <sub>PLH</sub> t <sub>PHL</sub>	1.5 3.3* 5†	— 4 2.9	123 13.7 9.8	— 3.8 2.7	135 15.1 10.8	ns
Clock to $\bar{Q}$ AC564	t <sub>PLH</sub> t <sub>PHL</sub>	1.5 3.3 5	— 4.1 2.9	128 14.4 10.3	— 4 2.8	141 15.8 11.3	ns
Output Enable to Q, $\bar{Q}$	t <sub>PZL</sub> t <sub>PZH</sub>	1.5 3.3 5	— 5.6 3.7	165 19.2 13.2	— 5.5 3.6	181 21.8 14.5	ns
Output Disable to Q, $\bar{Q}$	t <sub>PLZ</sub> t <sub>PHZ</sub>	1.5 3.3 5	— 4.7 3.7	165 16.5 13.2	— 4.5 3.6	181 18.1 14.5	ns
Power Dissipation Capacitance	C <sub>PD</sub> §	—	67 Typ.		67 Typ.		pF
Min. (Valley) V <sub>OH</sub> During Switching of Other Outputs (Output Under Test Not Switching)	V <sub>OHV</sub> See Fig. 1	5	4 Typ. @ 25°C				V
Max. (Peak) V <sub>OL</sub> During Switching of Other Outputs (Output Under Test Not Switching)	V <sub>OLP</sub> See Fig. 1	5	1 Typ. @ 25°C				V
Input Capacitance	C <sub>I</sub>	—	—	10	—	10	pF
3-State Output Capacitance	C <sub>O</sub>	—	—	15	—	15	pF

9

\*3.3 V: min. is @ 3.6 V  
max. is @ 3 V†5 V: min. is @ 5.5 V  
max. is @ 4.5 V§C<sub>PD</sub> is used to determine the dynamic power consumption, per flip flop.
$$P_D = C_{PD} V_{CC}^2 f_i + \sum V_{CC}^2 f_o C_L$$

where  $f_i$  = input frequency  
 $f_o$  = output frequency  
 $C_L$  = output load capacitance  
 $V_{CC}$  = supply voltage.

# Technical Data

## CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574

PREREQUISITE FOR SWITCHING: ACT Series

CHARACTERISTICS	SYMBOL	V <sub>CC</sub> (V)	AMBIENT TEMPERATURE (T <sub>A</sub> ) -°C				UNITS
			-40 to +85		-55 to +125		
			MIN.	MAX.	MIN.	MAX.	
Clock Pulse Width	t <sub>w</sub>	5†	3.9	—	4.5	—	ns
Setup Time Data to Clock	t <sub>su</sub>	5	2	—	2	—	ns
Hold Time Data to Clock	t <sub>h</sub>	5	2.6	—	3	—	ns
Maximum Clock Frequency	f <sub>max</sub>	5	125	—	110	—	MHz

†5 V: min. is @ 4.5 V

SWITCHING CHARACTERISTICS: ACT Series; t<sub>r</sub>, t<sub>f</sub> = 3 ns, C<sub>L</sub> = 50 pF

CHARACTERISTICS	SYMBOL	V <sub>CC</sub> (V)	AMBIENT TEMPERATURE (T <sub>A</sub> ) -°C				UNITS
			-40 to +85		-55 to +125		
			MIN.	MAX.	MIN.	MAX.	
Propagation Delays: Clock to Q ACT574	t <sub>PLH</sub> t <sub>PHL</sub>	5†	2.9	10.2	2.8	11.2	ns
Clock to Q̄ ACT564	t <sub>PLH</sub> t <sub>PHL</sub>	5	3	10.6	2.9	11.7	ns
Output Enable and Disable to Q ACT574	t <sub>PLZ</sub> t <sub>PHZ</sub> t <sub>PZL</sub> t <sub>PZH</sub>	5	3.7	13.2	3.6	14.5	ns
Output Enable and Disable to Q̄ ACT564	t <sub>PLZ</sub> t <sub>PHZ</sub> t <sub>PZL</sub> t <sub>PZH</sub>	5	3.7	13.2	3.6	14.5	ns
Power Dissipation Capacitance	C <sub>PD</sub> §	—	67 Typ.		67 Typ.		pF
Min. (Valley) V <sub>OH</sub> During Switching of Other Outputs (Output Under Test Not Switching)	V <sub>OHV</sub> See Fig. 1	5	4 Typ. @ 25°C				V
Max. (Peak) V <sub>OL</sub> During Switching of Other Outputs (Output Under Test Not Switching)	V <sub>OLP</sub> See Fig. 1	5	1 Typ. @ 25°C				V
Input Capacitance	C <sub>I</sub>	—	—	10	—	10	pF
3-State Output Capacitance	C <sub>O</sub>	—	—	15	—	15	pF

†5 V: min. is @ 5.5 V  
max. is @ 4.5 V

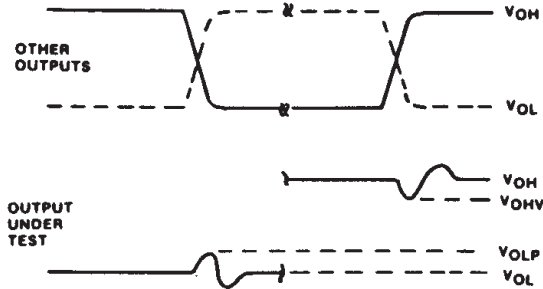
§C<sub>PD</sub> is used to determine the dynamic power consumption, per flip flop.

$P_D = C_{PD} V_{CC}^2 f_i + \sum V_{CC}^2 f_o C_L + V_{CC} \Delta I_{CC}$  where  $f_i$  = input frequency  
 $f_o$  = output frequency  
 $C_L$  = output load capacitance  
 $V_{CC}$  = supply voltage.

# Technical Data

## CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574

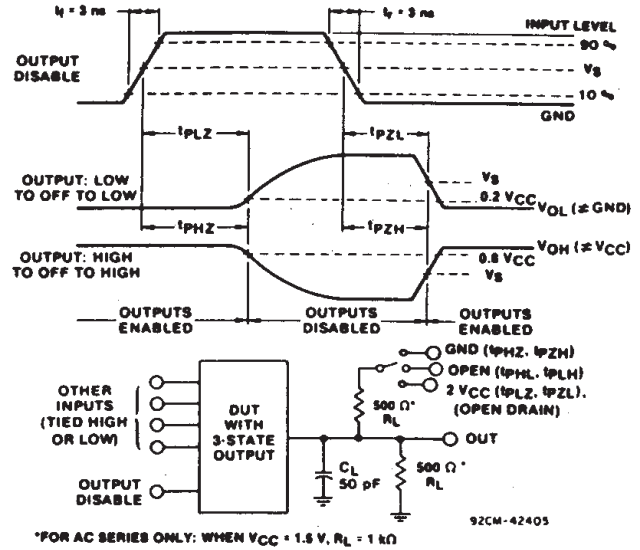
### PARAMETER MEASUREMENT INFORMATION



#### NOTES:

1.  $V_{OHV}$  and  $V_{OLP}$  are measured with respect to a GROUND REFERENCE NEAR THE OUTPUT UNDER TEST.
2. INPUT PULSES HAVE THE FOLLOWING CHARACTERISTICS:  
PRR  $\leq$  1 MHz,  $t_r = 3$  ns,  $t_f = 3$  ns, SKEW 1 ns.
3. R.F. FIXTURE WITH 700-MHz DESIGN RULES REQUIRED.  
IC SHOULD BE SOLDERED INTO TEST BOARD AND BYPASSED WITH 0.1  $\mu$ F CAPACITOR. SCOPE AND PROBES REQUIRE 700-MHz BANDWIDTH.

92CS-42406

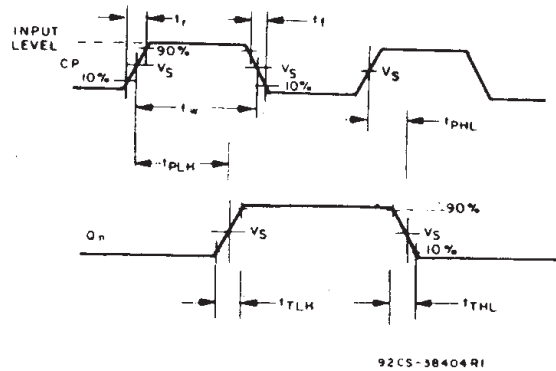


\*FOR AC SERIES ONLY: WHEN  $V_{CC} = 1.5$  V,  $R_L = 1$  k $\Omega$

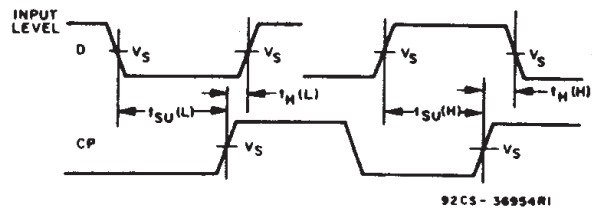
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Fig. 1 - Simultaneous switching transient waveforms.

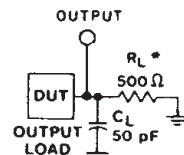
Fig. 2 - Three-state propagation delay waveforms and test circuit.



92CS-38404R1



92CS-38404R1



\*FOR AC SERIES ONLY: WHEN  
 $V_{CC} = 1.5$  V,  $R_L = 1$  k $\Omega$

92CS-42385

	CD54/74AC	CD54/74ACT
Input Level	$V_{CC}$	3 V
Input Switching Voltage, $V_S$	$0.5 V_{CC}$	1.5 V
Output Switching Voltage, $V_S$	$0.5 V_{CC}$	$0.5 V_{CC}$

Fig. 3 - Propagation delays times and test circuit.

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